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Feb 9, 2002

Docket Number: Chan-703A

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE UTILITY PATENT APPLICATION TRANSMITTAL LETTER

Box Patent Application Commissioner for Patents Washington, D.C. 20231

Sir:

Enclosed for filing is a continuation application of prior application 09/812,003 filed on March 19, 2001 by Hark Chan:

- a patent application for an invention entitled Information Distribution and Processing
   System (4 sheets of formal drawings and 18 pages of specification; 15 claims with 1 independent claim);
- (b) a declaration by the inventor, Hark C. Chan;
- (c) an Information Disclosure Statement with 6 sheets of PTO-1449; and
- (d) a Request and Certification under 35 U.S.C. 122(b)(2)(B)(i).

Applicant and Assignee are small entities. The Commissioner is authorized to charge any fees to Deposit Account No. 03-1243 (docket number: Chan-703A). A duplicate of this form is enclosed.

## Applicant's customer number is 23437, which corresponding to a mailing address of

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PATENT TRADEHARK OFFICE

Date: February 9, 2002

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Respectfully submitted,

Hark C. Chan



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## REQUEST AND CERTIFICATION UNDER 35 U.S.C. 122(b)(2)(B)(i)

First Named Inventor		Hark Chan
Title	Information Distribution and Processing System	
Atty Docket Number		CHAN-703A

I hereby certify that the invention disclosed in the attached application has not and will not be the subject of an application filed in another country, or under a multilateral agreement, that requires publication at eighteen months after filing. I hereby request that the attached application not be published under 35 U.S.C. 122(b).

Date
Signature

Hark Chan

Typed or printed name

This request must be signed in compliance with 37 CFR 1.33(b) and submitted with the application **upon filing**.

Applicant may rescind this nonpublication request at any time. If applicant rescinds a request that an application not be published under 35 U.S.C. 122(b), the application will be scheduled for publication at eighteen months from the earliest claimed filing date for which a benefit is claimed.

If applicant subsequently files an application directed to the invention disclosed in the attached application in another country, or under a multilateral international agreement, that requires publication of applications eighteen months after filing, the applicant must notify the United States Patent and Trademark Office of such filing within forty-five (45) days after the date of the filing of such foreign or international application. Failure to do so will result in abandonment of this application (35 U.S.C. 122(b)(2)(B)(iii)).

Burden Hour Statement: This collection of information is required by 37 CFR 1.213(a). The information is used by the public to request that an application not be published under 35 U.S.C. 122(b) (and the PTO to process that request). Confidentiality is governed by 35 U.S.C. 122 and 37 CFR 1.14. This form is estimated to take 6 minutes to complete. This time will vary depending upon the needs of the individual case. Any comments on the amount of time you are required to complete this form should be sent to the Chief Information Officer, U.S. Patent and Trademark Office, Washington, DC 20231. DO NOT SEND FEES OR COMPLETED FORMS TO THIS ADDRESS. SEND TO: Assistant Commissioner for Patents, Washington, DC 20231.